Nikaido, Marmelstein, Murray & Oram LLP Patent Application Declaration For U.S. Patent Application

My resid	ence, post off	entor, I hereby declare that? fice address and citizenship are as stated in all first and sole inventor (if only or or) of the subject matter which is claim DIO BASE STATION AND	e name is listed by	alow) or an o	riginal, first and joint ught on the invention e	inventor (if pentitled	plural	
-		nich is attached hereto unless the follo						
	was filed on	<u> </u>		as PCT International Application				
	Number	filed on as PCT International Application nber and was amended on as United States Application nber and was amended on						
and/or	was filed on	filed on as United States Application						
I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claim(s), as amended by any amendment referred to above. I acknowledge the duty to disclose information which is material to patentability as defined in 37 C.F.R. §1.56. I hereby claim foreign priority benefits under 35 U.S.C. §119(a)-(d) or §365(b) of any foreign application(s) for patent or inventor's certificate, or §365(a) of any PCT International application which designated at least one country other than the United States, listed below and have also identified below any foreign application for patent or inventor's certificate or PCT International Application having a filing date before that of the application(s) for which priority is claimed:								
		2000-35971	Japan	14/Fe	Feb./2000 Priority Claims			
forei 2ppli	prior gn ications. note A	(Number) (Co	ountry)	(Day/Mont	th/Year Filed)			
		(Number) (Co	ountry)	(Day/Mont	th/Year Filed)	☐ Yes		
	ack of page)	(Number) (Co	ountry)	(Day/Mont	th/Year Filed)	☐ Yes	□ No	
I hereby claim the benefit under 35 U.S.C. §119(e) of any United States provisional application(s) listed below.								
		(Application Number)	(Filing Da	(Filing Date)				
(Application Number) (Filing Date)								
of th	Note B on back is page)	☐ See attached list for a						
I hereby claim the benefit under 35 U.S.C. §120 of any United States application(s) or §365(c) of any PCT International application(s) designating the United States of America listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior application(s) (U.S. or PCT) in the manner provided by the first paragraph of 35, U.S.C. §112, I acknowledge the duty to disclose information which is material to patentability as defined in 37 C.F.R. §1.56 which became available between the filing date of the prior application and the national or PCT International filing date of this application.								
(List prio Application PCT Inter	ons or	(Application Serial No.)	(Filing Date)		(Status) (patented, per	ented, pending, abandoned)		
applicatio designatio	ng the U.S.)	(Application Serial No.)	(Filing Date)		(Status) (patented, per	ding, abando	oned)	
And I hereby appoint as principal attorneys David T. Nikaido, Reg. No. 22,663; Charles M. Marmelstein, Reg. No. 25,895; George E. Oram, Jr., Reg. No. 27,931; Robert B. Murray, Reg. No. 22,980; Martin S. Postman, Reg. No. 18,570; E. Marcie Emas, Reg. No. 32,131; Douglas H. Goldhush, Reg. No. 33,125; Kevin C. Brown, Reg. No. 32,402; Monica Chin Kitts, Reg. No. 36,105; Richard J. Berman, Reg. No. 39,107; King L. Wong, Reg. No. 37,500; and James A. Poulos, III, Reg. No. 31,714.								
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are beli	eved to be true re punishable l	all statements made herein of my own he; and further, that these statements we by fine or imprisonment, or both, under jeopardize the validity of the application.	ere made with the r Section 1001 of T ion or any patent i	knowledge the Fitle 18 of the ssued thereon	nat willful false stateme United States Code a	ents and the	like so	
(See Note		Full name of sole or first inventor		DA				
on back o this page)		Inventor's signature Akiya Ishida 2001/2/13						
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